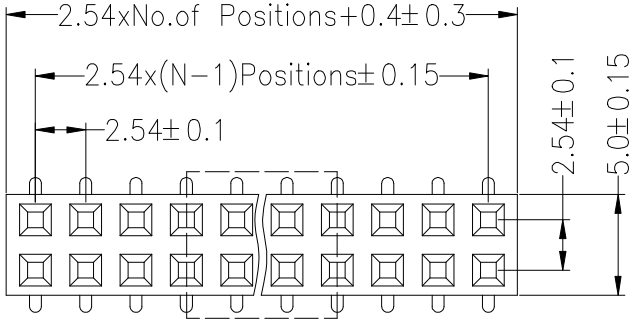
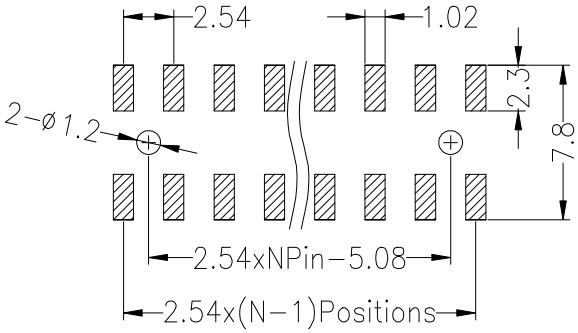
HSF RoHS

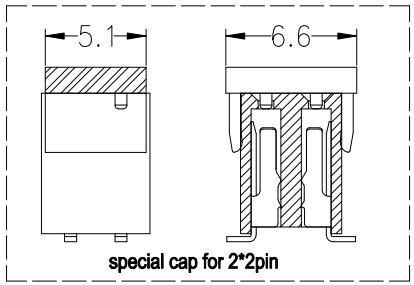
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°C to +105°C

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

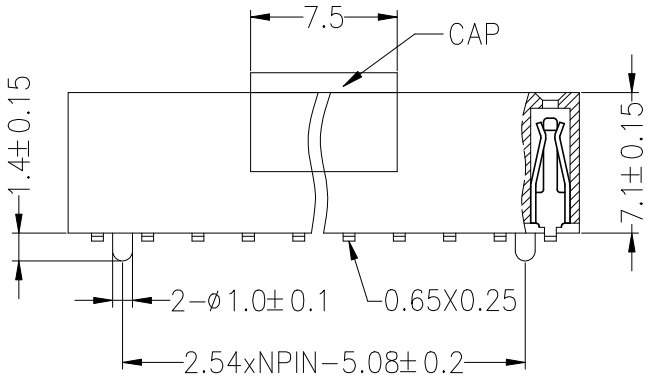


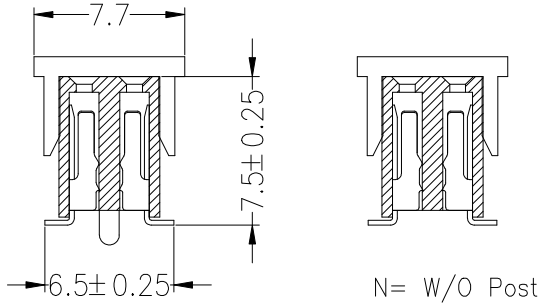


Ordering Information

2271 02 XX X X XX M U X 0X

No.of Pins Per Row 2~40	Insulator Material Option A=BK−PBT B=BK−PA66 C=BK−PA6T D=BK−PA46 E=BK−PA9T F=BK−LCP	Post W=With Post N=W/O Post	Contact Plating G1:Gold Flash G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold S0:Gold Flash/Tin SN:Tin	Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar	





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.09.14	NEW DRAWING	

OPERATION		DRAW	Liu Miao	21.09.14
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	227102XXXXXXMUX0X
TITLE:	2.54PF H7.1mm 2xNpin SMT W6.5